

Title (en)

A method of forming an embossed character on an IC card.

Title (de)

Verfahren zum Formen eines erhabenen Buchstabens auf einer Karte mit integrierten Schaltungen.

Title (fr)

Procédé pour former une lettre bosselée sur une carte de circuits intégrés.

Publication

**EP 0385583 A2 19900905 (EN)**

Application

**EP 90301020 A 19900131**

Priority

JP 2349489 A 19890131

Abstract (en)

A method of forming an embossed character on an IC card, comprising the steps of: applying a viscous resin, which adheres to the surface of the IC card and hardens when exposed to ultraviolet light, onto the surface of the IC card while forming a desired character with the resin; and projecting ultraviolet light onto the surface of the IC card so as to harden the resin applied in the form of the desired character.

IPC 1-7

**B42D 15/02**

IPC 8 full level

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CPC (source: EP US)

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